



SEA & LAND ELECTRONIC CORP.

[WWW.SEALAND-PPTC.COM](http://WWW.SEALAND-PPTC.COM)



ALPHA-TOP TECHNOLOGY CORP.

[WWW.ALPHA-TOP.CN](http://WWW.ALPHA-TOP.CN)

## APPROVAL SHEET

MODEL NO.: SMD0805-010-24V

CUSTOMER:

CUSTOMER'S APPROVAL:

AUTHORIZED SIGNATURE/STAMP:

DATE

MANUFACTURER:

HEAD OFFICE:

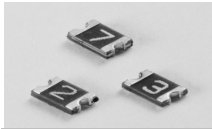
13F.,No.120-10,Sec.3,Zhongshan Rd.,Zhonghe Dist.,New Taipei City 23544,Taiwan  
Tel: 886-2-8221-2567  
Fax:882-2-2225-7268  
E-mail:service@chipfast.com.tw

China Branch:

Factory Building B)Shuangpeng,Weibu Village, Qiuchang Town,  
Huiyang District, Huizhou City, Guangdong Province, P.R.C.)  
Tel: 86-752-3562001  
Fax:86-752-3558696  
E-mail:service@atpptc.com

Submitted by: Chung Cheng  
Approved by: YC Lin  
DATE: 2-Mar-22

SEA & LAND ELECTRONIC CORP.



**Features**

- Surface Mount Devices
- Lead free device
- Size 2.0\*1.2 mm / 0.08\*0.05 inch
- Surface Mount packaging for automated assembly

**Applications**

- Almost anywhere there is a low voltage power supply, up to 15V and a load to be protected, including:
- Computer mother board, Modem, USB hub
  - PDAs & Charger, Analog & digital line card
  - Digital cameras, Disk drivers, CD-ROMs,

**SMD0805-010-24V**

Alpha-Top (Sea & Land Alliance)

**Performance Specification**

Model	Marking	V <sub>max</sub> (Vdc)	I <sub>max</sub> (A)	I <sub>hold</sub> @25°C (A)	I <sub>trip</sub> @25°C (A)	P <sub>d</sub> Typ. (W)	Maximum Time To Trip		Resistance		Agency Approval	
							Current (A)	Time (Sec)	R <sub>i min</sub> (Ω)	R <sub>1max</sub> (Ω)	UL	TUV
SMD0805-010-24V	I	24.0	100	0.10	0.30	0.5	0.5	1.50	1.000	6.000		

**I<sub>hold</sub>** = Hold Current. Maximum current device will not trip in 25°C still air.  
**I<sub>trip</sub>** = Trip Current. Minimum current at which the device will always trip in 25°C still air.  
**V<sub>max</sub>** = Maximum operating voltage device can withstand without damage at rated current (I<sub>max</sub>).  
**I<sub>max</sub>** = Maximum fault current device can withstand without damage at rated voltage (V<sub>max</sub>).  
**P<sub>d</sub>** = Power dissipation when device is in the tripped state in 25°C still air environment at rated voltage.  
**R<sub>imin/max</sub>** = Minimum/Maximum device resistance prior to tripping at 25°C.  
**R<sub>1max</sub>** = Maximum device resistance is measured one hour post reflow.  
**CAUTION** : Operation beyond the specified ratings may result in damage and possible arcing and flame.

**Environmental Specifications**

Test	Conditions	Resistance change
Passive aging	+85°C, 1000 hrs.	±5% typical
Humidity aging	+85°C, 85% R.H. , 168 hours	±5% typical
Thermal shock	+85°C to -40°C, 20 times	±33% typical
Resistance to solvent	MIL-STD-202, Method 215	No change
Vibration	MIL-STD-202, Method 201	No change
Ambient operating conditions : - 40 °C to +85 °C		
Maximum surface temperature of the device in the tripped state is 125 °C		

**Agency Approvals :**

**Regulation/Standard:**

 2015/863/EU  
 EN14582

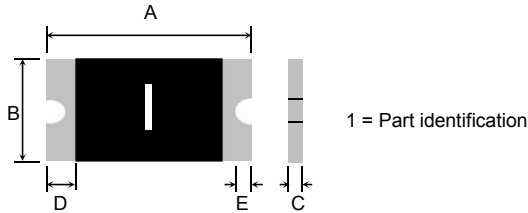
**I<sub>hold</sub> Versus Temperature**

Model	Maximum ambient operating temperature (T <sub>mao</sub> ) vs. hold current (I <sub>hold</sub> )								
	-40°C	-20°C	0°C	25°C	40°C	50°C	60°C	70°C	85°C
SMD0805-010-24V	0.140	0.120	0.110	0.10	0.080	0.070	0.060	0.050	0.030

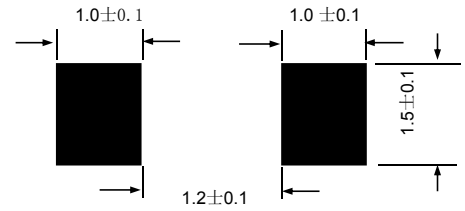
### Construction And Dimension (Unit:mm)

Model	A		B		C		D		E
	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.
SMD0805-010-24V	1.90	2.20	1.20	1.50	0.60	1.30	0.20	0.20	0.10

### Dimensions & Marking



### Recommended Pad Layout (mm)



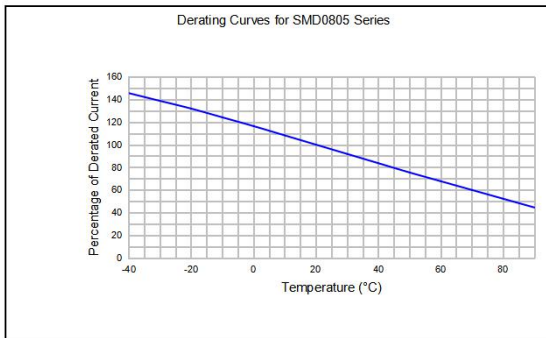
### Termination Pad Characteristics

Terminal pad materials : Tin-plated Nickel-Copper  
 Terminal pad solderability : Meets EIA specification RS186-9E and ANSI/J-STD-002 Category 3.

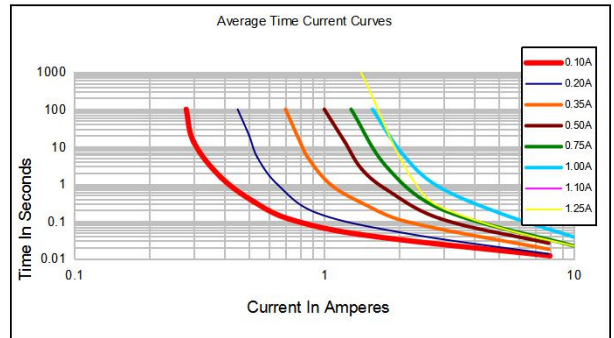
### Rework

Use standard industry practices, the removal device must be replaced with a fresh one.

### Thermal Derating Curve



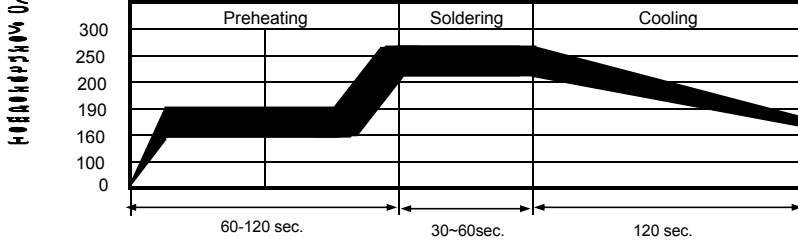
### Typical Time-To-Trip At 25°C



### WARNING:

- Use PPTC beyond the maximum ratings or improper use may result in device damage and possible electrical arcing and flame.
- PPTC are intended for protection against occasional over current or over temperature fault conditions and should not be used when repeated fault conditions or prolonged trip events are anticipated.
- Device performance can be impacted negatively if devices are handled in a manner inconsistent with recommended electronic, thermal, and mechanical procedures for electronic components.
- Use PPTC with a large inductance in circuit will generate a circuit voltage (L di/dt) above the rated voltage of the PPTC.
- Avoid impact PPTC device its thermal expansion like placed under pressure or installed in limited space.
- Contamination of the PPTC material with certain silicon based oils or some aggressive solvents can adversely impact the performance of the devices. PPTC SMD can be cleaned by standard methods.
- Requests that customers comply with our recommended solder pad layouts and recommended reflow profile. Improper board layouts or reflow profile could negatively impact solderability performance of our devices.

### Recommended Solder Reflow Conditions

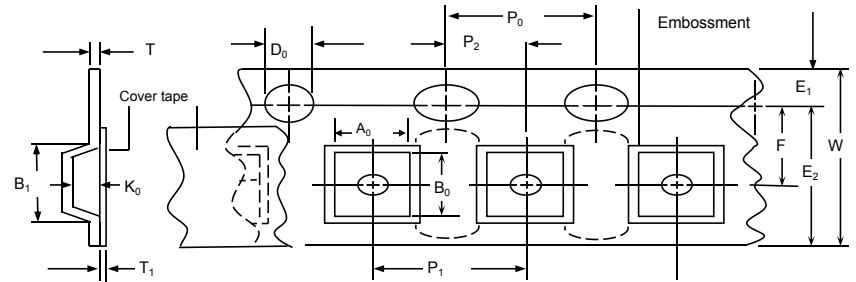


- Recommended reflow methods : IR, vapor phase oven, hot air oven.
  - Devices are not designed to be wave soldered to the bottom side of the board.
  - Recommended maximum paste thickness is 0.25 mm (0.010 inch).
  - Devices can be cleaned using standard method and solvents.
- Note : If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

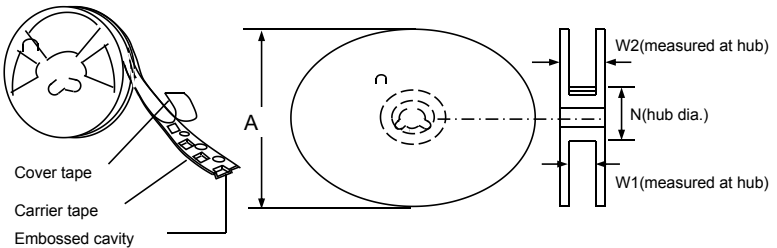
### Tape And Reel Specifications (mm)

Governing Specifications	EIA 481-1
W	8.0 ± 0.3
P0	4.0 ± 0.10
P1	4.0 ± 0.10
P2	2.0 ± 0.05
A0	1.45 ± 0.10
B0	2.30 ± 0.10
B1max.	4.35
D0	1.55 + 0.1, -0
F	3.5 ± 0.05
E1	1.75 ± 0.10
E2min.	6.25
T	0.25
T1max.	0.1
K0	0.74 ± 0.1
Leader min.	390
Trailer min.	160
<b>Reel Dimensions</b>	
A max.	178
N min.	60
W1	9.0 ± 0.5
W2	12.0 ± 0.05

### EIA Tape Component Dimensions



### EIA Reel Dimensions



### Storage And Handling

- Storage conditions : 40°C max, 70% R.H.
- Devices may not meet specified performance if storage conditions are exceeded.

### Order Information

SMD0805	010-24V	Packaging	Tape & Reel Quantity
Product name	Hold		
Size 2012 mm / 0805 inch	Current		5,000 pcs/reel
SMD: surface mount device	0.10A		

Tape & reel packaging per EIA481-1

Labeling Information

**TECHFUSE**  
**Sea & Land Electronic Corp.**

**HF**   **Pb**   **RoHS**

Model:  
Part no.:  
Spec.:  
Lot no.:  
Q'ty:

倉儲：密封！溫度：18~33°C/濕度：30~60% A